Electronic Patent Application Fee Transmittal							
Application Number:	105	10578028					
Filing Date:	27-	27-Apr-2006					
Title of Invention:	Thi	Thin film diode panel and manufacturing method of the same					
First Named Inventor/Applicant Name:	Kyoung-Ju Shin						
Filer:	David S. Park/Annie McNally						
Attorney Docket Number:	AB-1883 US						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Request for continued examination	1801	1	810	810
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